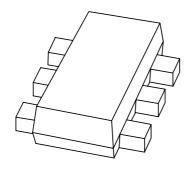
DISCRETE SEMICONDUCTORS

DATA SHEET



PEMF2112 V PNP loadswitch

Product data sheet 2004 Jan 12



12 V PNP loadswitch

PEMF21

FEATURES

- Low V_{CEsat} transistor and resistor-equipped transistor in one package
- Very small 1.6 × 1.2 mm ultra thin package
- Reduced component count.

APPLICATIONS

- Line switches
- · Battery charger switches
- · Power supply switches
- Drive switches
- General purpose analog switches.

DESCRIPTION

Low V_{CEsat} PNP transistor and NPN resistor-equipped transistor in a SOT666 plastic package (see "Ordering information" for package details).

MARKING

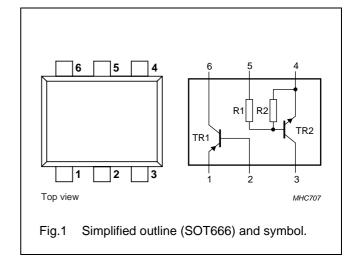
TYPE NUMBER	MARKING CODE
PEMF21	2F

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT		
TR1; PNP	TR1; PNP; low V _{CEsat} transistor					
V _{CEO}	collector-emitter voltage	_	-12	V		
I _C	collector current (DC)	_	-500	mA		
R _{CEsat}	equivalent on-resistance	_	500	mΩ		
TR2; NPN	TR2; NPN; resistor-equipped transistor					
V _{CEO}	collector-emitter voltage	_	50	V		
Io	output current (DC)	_	100	mA		
R1	bias resistor	10	_	kΩ		
R2	bias resistor	10	– kΩ			

PINNING

PIN	DESCRIPTION	
1	emitter TR1	
2	base TR1	
3	collector TR2	
4	emitter TR2	
5	base TR2	
6	collector TR1	



ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
TIPE NOWIBER	NAME	NAME DESCRIPTION VERSION			
PEMF21	 plastic surface mounted package; 6 leads SOT6		SOT666		

12 V PNP loadswitch

PEMF21

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Transistor TR1					
V _{CBO}	collector-base voltage	open emitter	_	-15	V
V_{CEO}	collector-emitter voltage	open base	_	-12	V
V _{EBO}	emitter-base voltage	open collector	_	-6	V
I _C	collector current (DC)		_	-500	mA
I _{CM}	peak collector current		_	-1	А
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	200	mW
Transistor TR2			<u>.</u>		-
V_{CBO}	collector-base voltage	open emitter	_	50	V
V_{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
Vi	input voltage				
	positive		_	+40	V
	negative		_	-10	V
I _O	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	200	mW
Per device					
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	300	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per device				
R _{th(j-a)}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

Notes

- 1. Transistor mounted on an FR4 printed-circuit board.
- 2. Reflow soldering is the only recommended soldering method.

^{1.} Transistor mounted on an FR4 printed-circuit board.

12 V PNP loadswitch

PEMF21

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

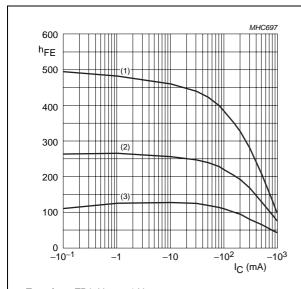
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Transistor	Transistor TR1						
I _{CBO}	collector-base cut-off current	$V_{CB} = -15 \text{ V}; I_E = 0$	_	_	-100	nA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_{C} = 0$	_	_	-100	nA	
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -10 \text{ mA}$	200	_	_		
V _{CEsat}	collector-emitter saturation voltage	$I_C = -200 \text{ mA}; I_B = -10 \text{ mA}$	_	_	-250	mV	
R _{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	_	300	500	mΩ	
V _{BEsat}	base-emitter saturation voltage	$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	-	_	-1.1	V	
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note 1}$	_	_	-0.9	V	
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	280	_	MHz	
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0; f = 1 \text{ MHz}$	_	_	10	pF	
Transistor	Transistor TR2						
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA	
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_{B} = 0$	-	_	1	μΑ	
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	-	_	400	μΑ	
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	30	_	-		
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	300	mV	
V _{i(off)}	input-off voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	_	_	0.5	V	
V _{i(on)}	input-on voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 10 \text{ mA}$	3	_	-	V	
R1	input resistor		7	10	13	kΩ	
<u>R2</u> R1	resistor ratio		0.8	1	1.2		
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0; f = 1 \text{ MHz}$	_	-	2.5	pF	

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

12 V PNP loadswitch

PEMF21



Transistor TR1; $V_{CE} = -2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.2 DC current gain as a function of collector current; typical values.

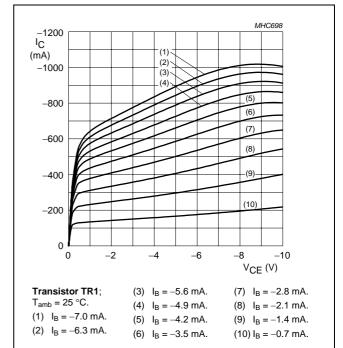
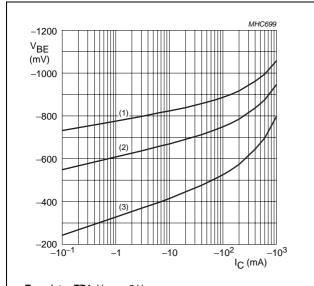


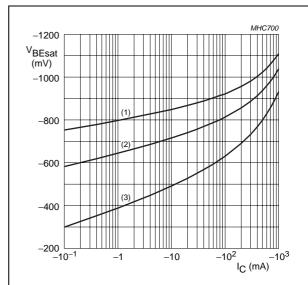
Fig.3 Collector current as a function of collector-emitter voltage; typical values.



Transistor TR1; V_{CE} = -2~V.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}\text{C}$.

Fig.4 Base-emitter voltage as a function of collector current; typical values.



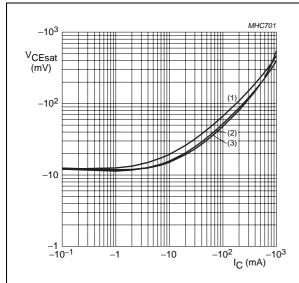
Transistor TR1; $I_C/I_B = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

12 V PNP loadswitch

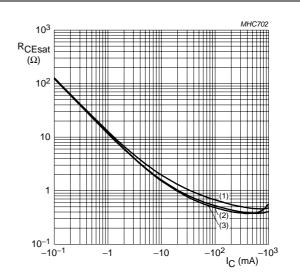
PEMF21



Transistor TR1; $I_C/I_B = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

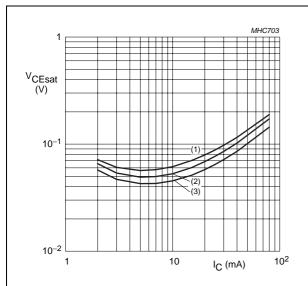
Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



Transistor TR1; $I_C/I_B = 20$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

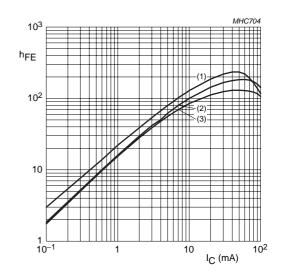
Fig.7 Equivalent on-resistance as a function of collector current; typical values.



Transistor TR2; $I_C/I_B = 20$.

- (1) $T_{amb} = 100 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -40 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



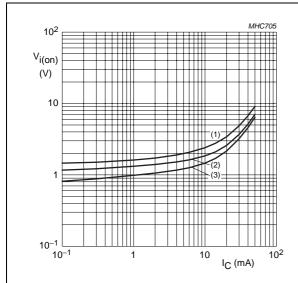
Transistor TR2; $V_{CE} = 5 \text{ V}.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -40 \, ^{\circ}C$.

Fig.9 DC current gain as a function of collector current; typical values.

12 V PNP loadswitch

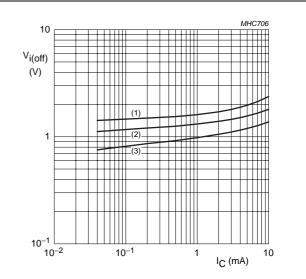
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Transistor TR2; $V_{CE} = 0.3 \text{ V}.$

- (1) $T_{amb} = -40 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

Fig.10 Input-on voltage as a function of collector current; typical values.



Transistor TR2; $V_{CE} = 5 V$.

- (1) $T_{amb} = -40 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \,^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

Fig.11 Input-off voltage as a function of collector current; typical values.

2004 Jan 12

7

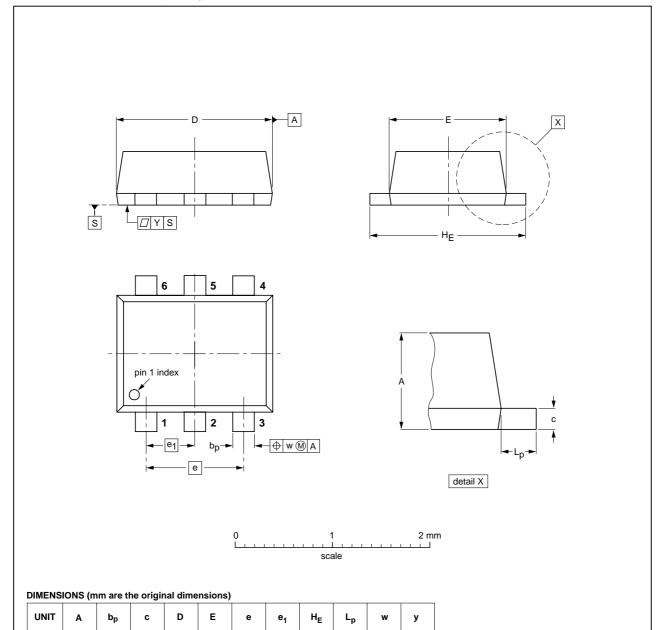
12 V PNP loadswitch

PEMF21

PACKAGE OUTLINE

Plastic surface-mounted package; 6 leads

SOT666



OUTLINE	REFERENCES		EUROPEAN	ICCUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT666						-04-11-08- 06-03-16

0.1

0.1

1.0

0.5

2004 Jan 12 8

0.6

0.5

0.27

0.17

0.18

1.5

1.1

12 V PNP loadswitch

PEMF21

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
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Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Contact information

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